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7-1542006-1 Product Details



7-1542006-1

TE Part Number: 7-1542006-1

Add to Part List

Heat Sink Assemblies

Always EU RoHS/ELV Compliant (Statement of Compliance)

Product Highlights:

- Heat Sink
- BGA
- Package Size = 35 [1.379] mm [in]
 For Use With BGA Semiconductor Packages
- · Power Air Velocity Thermal Resistance

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Documentation & Additional Information

Product Drawings:

• 35mm PIN FIN HEATSINK ASSEMBLY (HTS429NF-U) (PDF, English)

Catalog Pages/Data Sheets:

Product Specifications:

· None Available

Application Specifications:

None Available

Instruction Sheets:

· None Available

CAD Files:

· None Available

Additional Information:

Product Line Information

Additional Product Images:

- Line Drawing
- Thermal Resistance Chart

Related Products:

Tooling

Product Features (Please use the Product Drawing for all design activity

Product Type Features:

- Product Type = Heat Sink
- Device Type = BGA
- For Use With = BGA Semiconductor Packages
- Finish = Black Anodize
- Material = Cold-Forged Aluminum
- Comment = Mounting clip does not increase overall heat sink height.; Heat sink assembly includes Four Leg Low Profile Clip, Part Number 1542385-1.

Electrical Characteristics:

- <u>Heat Sink Type</u> = Pin Fin 2
- Fan Type = No Fan

Termination Related Features:
• Height (mm [in]) = 19.05 [0.750]

Body Related Features:

List all Documents

- Package Size (mm [in]) = 35 [1.379]
- Flammability Rating = UL 94V-0

Configuration Related Features:

Diameter (mm [in]) = 34.95 [1.376]

Industry Standards:

- RoHS/ELV Compliance = RoHS compliant, ELV compliant
- <u>Lead Free Solder Processes</u> = Not relevant for lead free process
- RoHS/ELV Compliance History = Always was RoHS compliant

- Brand = Tyco Electronics
- Line = ChipCoolers

| Interrelated Features | | |
|-----------------------|----------------------|-----------------------------|
| When Power (W) is: | And Air Velocity is: | Thermal Resistance (°C) is: |
| 5.0 | 0 LFM | 8.94 |
| 5.0 | 200 LFM | 4.15 |
| 5.0 | 400 LFM | 3.26 |
| 5.0 | 600 LFM | 2.15 |
| 10.0 | 0 LFM | 8.24 |
| 10.0 | 200 LFM | 4.38 |
| 10.0 | 400 LFM | 3.19 |
| 10.0 | 600 LFM | 2.35 |
| 15.0 | 0 LFM | 7.69 |
| 15.0 | 200 LFM | 4.47 |
| 15.0 | 400 LFM | 3.24 |
| 15.0 | 600 LFM | 2.41 |

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